TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74ACT240P,TC74ACT240F, TC74ACT240FT TC74ACT244P,TC74ACT244F, TC74ACT244FT

Octal Bus Buffer

TC74ACT240P/F/FT Inverted, 3-State

Outputs

TC74ACT244P/F/FT Non-Inverted, 3-State

Outputs

The TC74ACT240 and 244 are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The 74ACT240 is an inverting 3-state buffer while the 74ACT244 is non-inverting. Both devices have two active-low output enables.

These devices are designed to be used in such applications as 3-state memory address drivers.

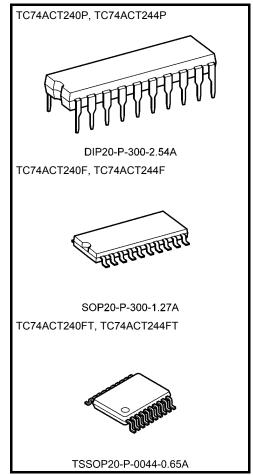
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $t_{pd} = 5.0$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 8 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- Compatible with TTL outputs:  $V_{IL} = 0.8 \text{ V (max)}$  $V_{IH} = 2.0 \text{ V (min)}$
- Symmetrical output impedance: | IOH | = IOL = 24 mA (min)

Capability of driving 50  $\Omega$  transmission lines.

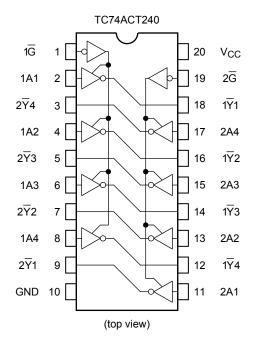
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Pin and function compatible with 74F240/244

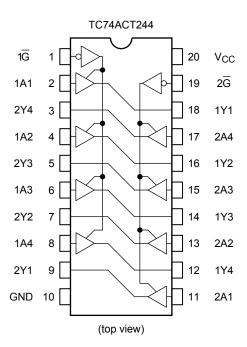


Weight

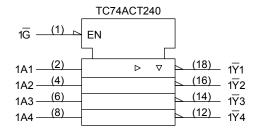
DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.)

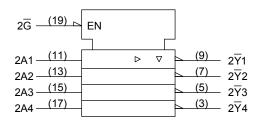
## **Pin Assignment**

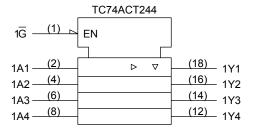


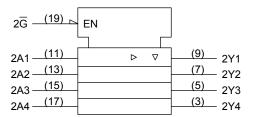


## **IEC Logic Symbol**









#### **Truth Table**

Inputs		Outputs				
G	A <sub>n</sub>	Y <sub>n</sub> (244)	Ÿ <sub>n</sub> (240)			
L	L	L	Н			
L	Н	Н	L			
Н	Х	Z	Z			

X: Don't care

Z: High impedance

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## **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±50	mA
DC output current	lout	±50	mA
DC V <sub>CC</sub> /ground current	I <sub>CC</sub>	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	<b>V</b>
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	<b>V</b>
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
Input rise and fall time	dt/dV	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either VCC or GND.

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#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition VCC (V)			Ta = 25°C			Ta = -40 to 85°C		Unit	
	Cymbol					Min	Тур.	Max	Min	Max	Offic
High-level input voltage	V <sub>IH</sub>	_			4.5 to 5.5	2.0	-	_	2.0	_	V
Low-level input voltage	V <sub>IL</sub>	_			4.5 to 5.5	_	1	0.8	-	0.8	V
	Voн	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		4.5	4.4	4.5	_	4.4	_	
High-level output voltage			I <sub>OH</sub> = −24 mA		4.5	3.94	_	_	3.80	_	V
			I <sub>OH</sub> = -75 mA	(Note)	5.5	_	_	_	3.85	_	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA		4.5	_	0.0	0.1	_	0.1	
Low-level output voltage			I <sub>OL</sub> = 24 mA		4.5	_	_	0.36	_	0.44	V
Vollago			I <sub>OL</sub> = 75 mA	(Note)	5.5	_	_	_	_	1.65	
3-state output off-state current	l <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND			5.5	_		±0.5	_	±5.0	μΑ
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	-	±0.1	_	±1.0	μΑ
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	_	8.0	_	80.0	μA
	Ic	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND			5.5	_	_	1.35	_	1.5	mA

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

### AC Characteristics ( $C_L = 50 \text{ pF}$ , $R_L = 500 \Omega$ , input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	- J		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay	t <sub>pLH</sub>		5.0 ± 0.5	_	5.7	8.0	1.0	9.0	ns
time	t <sub>pHL</sub>	_							
Output enable time	t <sub>pZL</sub>		5.0 ± 0.5	_	6.0	9.0	1.0	10.5	ns
Output enable time	t <sub>pZH</sub>	_							
Output disable time	t <sub>pLZ</sub>		5.0 ± 0.5	_	5.9	8.5	1.0	10.0	ns
Output disable time	t <sub>pHZ</sub>								
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Output capacitance	C <sub>OUT</sub>	_		_	10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub>	TC74ACT240		_	25	_	_	_	nE.
	(Note)	TC74ACT244		_	29	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

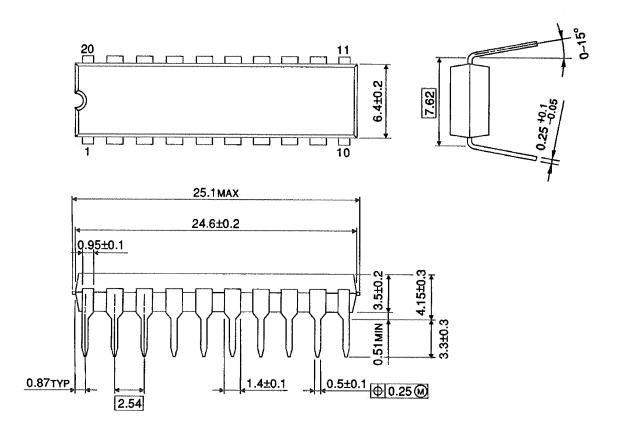
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Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per bit)$ 

# **Package Dimensions**

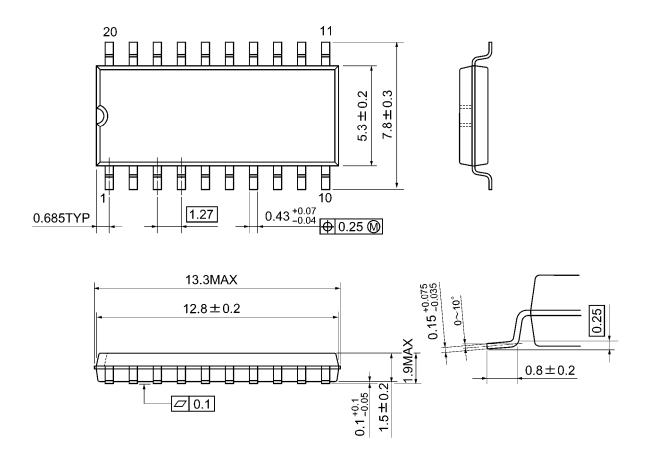
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

# **Package Dimensions**

SOP20-P-300-1.27A Unit: mm



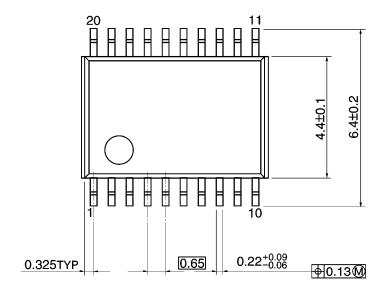
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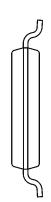
Weight: 0.22 g (typ.)

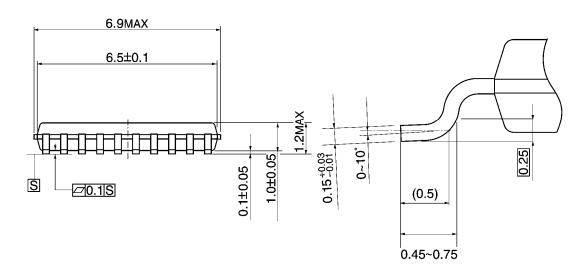
# **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm







Weight: 0.08 g (typ.)



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